



2 3 4 5 6 8 9 0 APPLICATION INSTRUCTION Note: it must be insert microSD card first, remove last if applied. ITEM **DESCRIPTION** QT'Y HOUSING, BLACK 1PC A. Insert the microSD Card CONTACT, G/F ON TAIL, 8 PCS 5u" GOLD ON CONTACT AREA 3 METAL SHELL, Mylar Label 1 PC CONTACT, G/F ON TAIL, 6 PCS 5u" GOLD ON CONTACT AREA METAL SHELL, WITH LIP 1 PC 4 PCS SOLDER PAD, GOLD FLASH 1. Rise the shell lightly MicroSD Label 1 PCS 2. Shell opened 3. insert the microSD card MECHANICAL INSULATOR: HIGH TEMPERATURE THERMOPLASTIC, UL94 V-0 RATED. COLOR OF INSULATOR: BLACK CONTACT: COPPER ALLOY CONTACT FINISH: GOLD ON MATING AREA; FLASH GOLD ON SOLDER TAILS; ALL OVER 50u" NICKEL UNDER-PLATED. SHELL: STAINLESS STEEL GROUND PAD: COPPER ALLOY 5. Slide into the guide rail 6. Upto the shell bottom 4. Another view GROUND PAD: GOLD OVER NICKEL UNDER-PLATED Ε **DURABILITY: 6,000 CYCLES MINIMUM** ELECTRICAL CONTACT RESISTANCE: 100 MILLIOHMS MAXIMUM INSULATION RESISTANCE: 1000M OHM MINIMUM AT 500 VDC. DIELECTRIC WITHSTANDING VOLTAGE: 500 VAC/RMS FOR ONE MINUTE D CURRENT RATING: 0.5A MAXIMUM **ENVIRONMENT** 8. Snop-on 7. Turn the shell back 9. OK OPERATING TEMPERATURE: -25°C TO +85°C MOISTURE SENSITITY LEVEL: 5 (48 HOURS FLOOR LIFE). В PART NO. SCTF-W09P2G-0608 DWG NO. SCTF-W09P2G-0608 CHECKED BY CY **TOLERANCES ARE** ASSEMBLIES DESCRIP TION: $.X \pm 0.2$ FILE NO. DRAWING BY XX ± 煜倫股份有限公司 XXX ± PROJECTION (A) UNIT / mm SCALE 1:1 **AREA REVISIONS** AWG HK DATE